

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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SB07-03P

ON Semiconductor®

Schottky Barrier Diode 30V, 0.7A, Low IR, Single PCP

http://onsemi.com

Applications

· High frequency rectification (switching regulators, converters, choppers)

Features

- Low forward voltage (VF max=0.55V)
- · Low switching noise
- · Low leakage current and high reliability due to highly reliable planar structure

Specifications

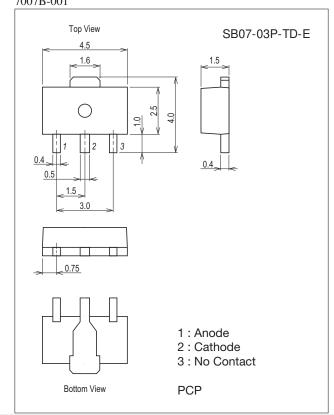
Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Conditions	Ratings	Unit
Repetitive Peak Reverse Voltage	VRRM		30	V
Nonrepetitive Peak Reverse Surge Voltage	VRSM		35	V
Average Output Current	IO		700	mA
Surge Forward Current	IFSM	50Hz sine wave, 1 cycle	5	Α
Junction Temperature	Tj		-55 to +125	°C
Storage Temperature	Tstg		-55 to +125	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

Package Dimensions

unit : mm (typ) 7007B-001



Product & Package Information

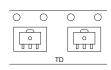
• Package : PCP

• JEITA, JEDEC : SC-62, SOT-89, TO-243

• Fast reverse recovery time (t_{rr} max=10ns)

• Minimum Packing Quantity: 1,000 pcs./reel

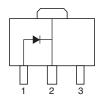
Packing Type: TD



Marking



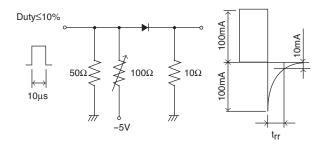
Electrical Connection



Electrical Characteristics at Ta=25°C

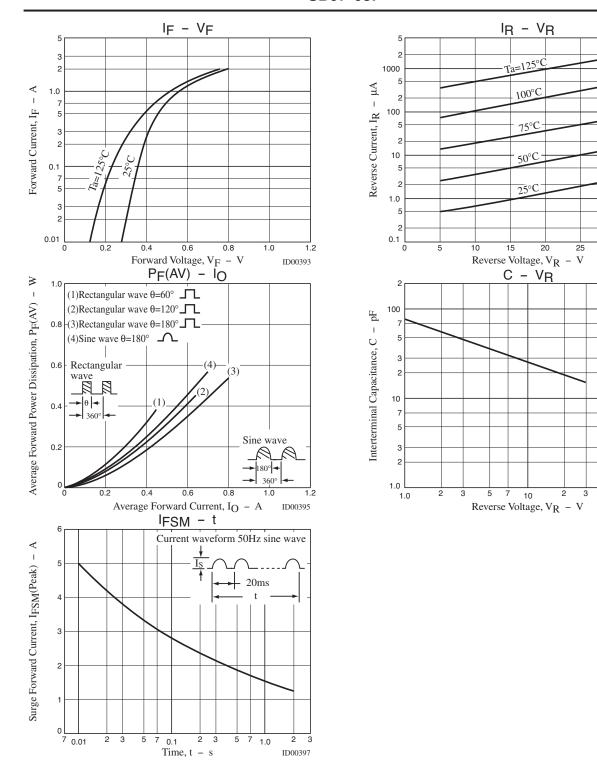
Parameter	Symbol	Conditions	Ratings			Unit
		Conditions	min	typ	max	Offic
Reverse Voltage	VR	I _R =300μA	30			V
Forward Voltage	VF	IF=700mA			0.55	V
Reverse Current	IR	V _R =15V			80	μΑ
Interterminal Capacitance	С	V _R =10V, f=1MHz		26		pF
Reverse Recovery Time	t _{rr}	IF=IR=100mA, See specified Test Circuit.			10	ns
hermal Resistance	Rth(j-a)1			310		°C / W
memai nesistance	Rth(j-a)2	When mounted on ceramic substrate (250mm ² ×0.8mm)		120		°C / W

trr Test Circuit



Ordering Information

Device Package		Shipping	memo		
SB07-03P-TD-E	PCP	1,000pcs./reel	Pb Free		



ID00394

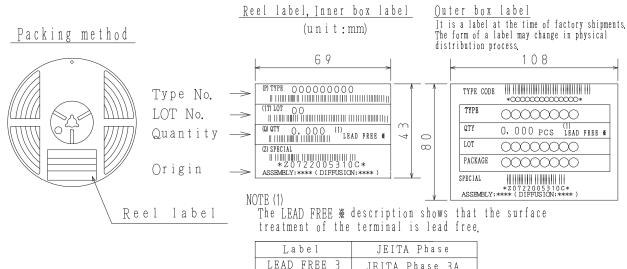
f=1MHz

Embossed Taping Specification

SB07-03P-TD-E

1. Packing Format

Package Name	Carrier Tape	Maximum Number of devices contained (pcs)			Packing format		
	Туре	Reel	Inner box	Outer box	Inner BOX (C-1)	Outer BOX (A-7)	
PCP	PCP	1, 000	4,000	24,000	4 reels contained	6 inner boxes contained	
					Dimensions:mm (external)	Dimensions:mm (external)	
					183×72×185	440×195×210	

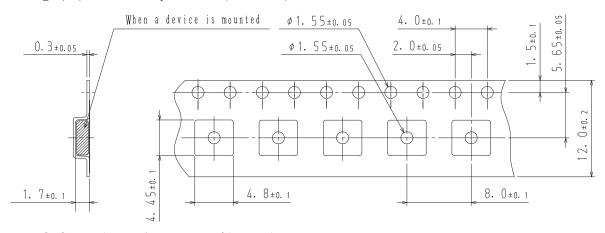


JEITA Phase 3A

JEITA Phase 3

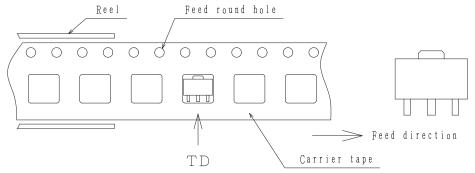
2. Taping configuration

2-1. Carrier tape size (unit:mm)



LEAD FREE 4

2-2. Device placement direction



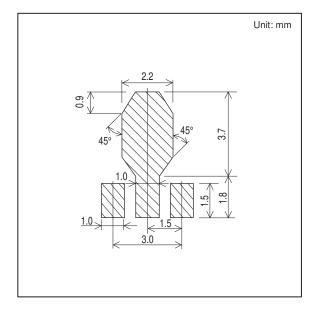
Those with pin 1 index on the feed hole side·····TD

Outline Drawing

SB07-03P-TD-E

Mass (g) Unit 0.058 *For reference mm 4. 5±0. 1 1. 6±0. 2 _ 1.5±0.1_ 2. 5±0. 1 4. 0±0. 2 1. 0±0. 2 0. 4+0. 08 0. 4±0. 03 0. 5^{+0. 05} 1. 5±0. 2 3. O±0. 2 0. 75 0.10 *1:Lot indication

Land Pattern Example



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